

Technical Data

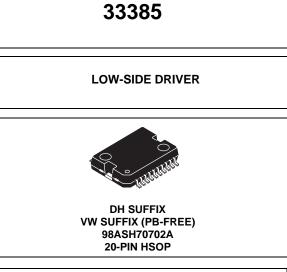
Quad Low-side Driver

The MC33385 is a Quad Low-side Driver fully protected switch. This device is a general purpose Low-side Driver but has been especially designed to operate in engine management applications as injector driver or automotive gear box. It is interfaced directly with a microcontroller for parallel control of the load and the individual output diagnostic is done through a SPI. The diagnostic logic recognizes 4 failure types at each output stage: overcurrent, short to GND, open load, and over-temperature.

Features

ARCHIVE INFORMATION

- RDSON of 250mΩ per Output at 25°C
- Supplied from the main 5V V_{CC}
- Input CMOS Compatible
- Diagnostic through SPI
- Nominal Current of 2A per Output
- Current Limitation at 3A with Automatic Turn Off
- Output Internally Clamped at 50V typ for Inductive Load Drive
- Junction to Case Thermal Resistance of 4.4°C/W
- Individual Output over Temperature Shutdown
- Pb-Free Packaging Designated by Suffix Code VW



ORDERING INFORMATION					
Device	Temperature Range (T _A)	Package			
MC33385DH/R2	-40°C to 125°C	20 HSOP			
MC33385VW/R2	-40 C to 125 C	20 H30P			

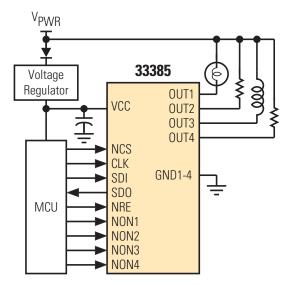
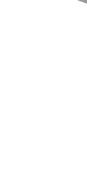


Figure 1. MC33385 Simplified Application Diagram



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BLOCK DIAGRAM

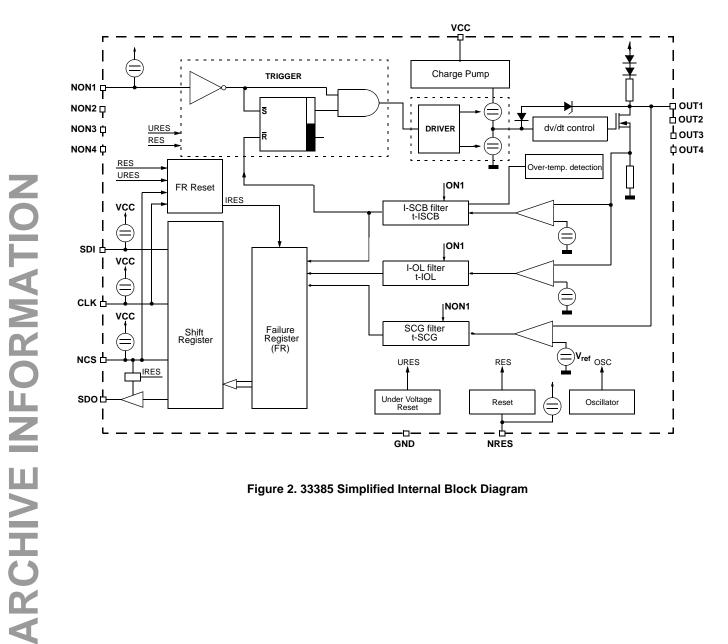


Figure 2. 33385 Simplified Internal Block Diagram



ARCHIVE INFORMATION

PIN CONNECTIONS

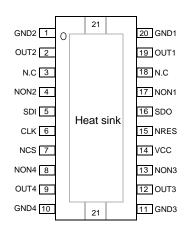


Figure 3. 33385 Pin Connections

Table 1. 33385 Pin Definitions

Pin Number	Pin Name	Definition
1	GND2	Ground 2
2	OUT2	Output Channel 2
3		NC
4	NON2	Input Control Signal for Channel 2
5	SDI	Serial Data Input
6	CLK	Clock Line for Serial Interface
7	NCS	Chip Select for Serial Interface
8	NON4	Input Control Signal for Channel 4
9	OUT4	Output Channel 4
10	GND4	Ground 4
11	GND3	Ground 3
12	OUT3	Output Channel 3
13	NON3	Input Control Signal for Channel 3
14	Vcc	5V Power Supply
15	NRES	Reset Input
16	SDO	Data Output of Serial Interface
17	NON1	Input Control Signal Channel 1
18		NC
19	OUT1	Output Channel 1
20	GND1	Ground 1
	Case	Connected to the PCB Ground for Thermal Purposes



ELECTRICAL CHARACTERISTICS

MAXIMUM RATINGS

Table 2. Maximum Ratings

All voltages are with respect to ground unless otherwise noted. Exceeding these ratings may cause a malfunction or permanent damage to the device.

Ratings	Symbol	Value	Unit
ELECTRICAL RATINGS		1	I
Voltage Range	Vcc	7.0	V
Continuous Output Voltage (With no reverse current)	V _{OUT}	45	V
Continuous Current	I _{OUTC}	2.5	А
Peak Output Current	I _{OUTP}	I _{SCBMAX}	А
Clamped Energy at the Switching OFF (See Figure 9)	W _{OFF}	70	mJ for 1ms
Input Voltage (Inputs)	V _{IN}	V _{CC} + 0.3	V
Input Protection Diode Current	I _{IN}	1.0	mA
Input Voltage (Outputs)	V _O	V _{CC} + 0.3	V
Input Protection Diode Current	Ι _Ο	1.0	mA
THERMAL RATINGS		·	·
Operating Junction Temperature	ТJ	150	°C
Thermal Resistance : Junction-case (One power stage in use)	R _{THJC}	4.5	kΩ
Thermal Resistance : Junction-ambient (Device soldered on printed circuit board)	R _{THJA}	50	kΩ
Peak Package Reflow Temperature During Reflow ⁽¹⁾ , ⁽²⁾	T _{PPRT}	Note 2	°C

Notes

ARCHIVE INFORMATION

1. Pin soldering temperature limit is for 10 seconds maximum duration. Not designed for immersion soldering. Exceeding these limits may cause malfunction or permanent damage to the device.

2. Freescale's Package Reflow capability meets Pb-free requirements for JEDEC standard J-STD-020C. For Peak Package Reflow Temperature and Moisture Sensitivity Levels (MSL),

Go to www.freescale.com, search by part number [e.g. remove prefixes/suffixes and enter the core ID to view all orderable parts. (i.e. MC33xxxD enter 33xxx), and review parametrics.



STATIC CHARACTERISTICS

Table 3. Static Electrical Characteristics

Characteristics noted under conditions 7.0 V \leq V_{SUP} \leq 18 V, -40°C \leq T_A \leq 125°C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
SUPPLY VOLTAGE		<u> </u>		<u> </u>	
Supply Voltage Range	V _{CC}	4.5		5.5	V
JUNCTION TEMPERATURE					
Junction Temperature Continuous (Continuous)	T _{J1}	- 40		150	°C
Junction Temperature Dynamical (Time limited)	T _{J2}			185	°C
OUTPUT CURRENT					
Output Current Range	I _{OUT}			I _{SCBMAX}	А
RESET BEHAVIOUR					
Reset Changeable (at NRES-Pin)	V _{CC}	V _{CCRES}		5.5	V
Undervoltage Reset (Independent of NRES)	V _{CCRES}	3.35		3.95	V
Active for $V_{CC} = 0V$ to V_{CCPRO}					
UNDERVOLTAGE PROTECTION					
Protection active for V _{CC} =0V to V _{CCPRO}	V _{CCPRO}	1.5		4.0	V
OVER TEMPERATURE					
Temperature Detection Threshold	T _{OFF}	155		185	°C
SUPPLY CURRENT		•			
Standby Current (without load) (NON1NON4 = High Level)					
$5.15V \ge V_{CC}$	I _{CCSTB1}			6.0	mA
$5.5V \ge V_{CC}$	I _{CCSTB2}			7.0	mA
Operating Mode (For $5.15V \ge V_{CC}$) (lout 14) = 2A	I _{CCOPM}			17	mA
ΔI_{CC} During Reverse Output Current	ΔI_{CC}			100	mA
(I _{OUT} = - 5A on one output)				50	mA
INPUTS (NONx, NCS, CLK, NRES, SDI)					
Low Threshold	V _{INL}	-0.3		0.2*V _{CC}	V
High Threshold	V _{INH}	0.7*V _{CC}		V _{CC} + 0.3	V
Hysteresis	V _{HYST}	0.85			V
Input Current (V _{IN} = V _{CC})	I _{IN}			10	μA
Input Current (V _{CC} >V _{RES} & 0V <v<sub>IN < 0.9^*V_{CC})</v<sub>	I _{IN}	- 100		- 20	μA
SERIAL DATA OUTPUT		<u> </u>		<u> </u>	
High Output Level (I _{SDO} = -2mA)	V _{SDOH}	V _{CC} - 0.4			V
Low Output Level (I _{SDO} = 3.2mA)	V _{SDOL}			0.4	V
Tristate Leakage Current (NCS = HIGH, V_{SDO} = 0V to V_{CC})	I _{SDOL}	- 10		10	μA
OUTPUTS (OUT 14)	I	_ .		I	
Average Output Current	I _{OUTA}	2.5			А
Output Peak Current	I _{OUTP}	I _{SCBMAX}			А



Table 3. Static Electrical Characteristics (continued)

Characteristics noted under conditions 7.0 V \leq V_{SUP} \leq 18 V, -40°C \leq T_A \leq 125°C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
Leakage Current 1 (NON = High, V_{OUT} = 25V, V_{CC} = 5V)	I _{OUTL}			10	μΑ
Leakage Current 2 (NON = High, V_{OUT} = 16V, V_{CC} = 1V)	I _{OUTL2}			10	μA
Output Clamp Voltage (I _{OUT} = 1A)	V _{CLP}	45	50	58	V
Matching Clamp Voltage (Between two outputs)	V _{CLPM}	V _{CLP-1}		V _{CLP+1}	V
Clamped Energy at the Switching OFF (See Figure 9)	W _{OFF}	50			mJ for 1ms
On Resistance (I _{OUT} = 2A, T _J = 150°C, NON = LOW)	R _{DSON}			500	mΩ
Output Low Voltage Limitation (I _{OUT} = 150mA)	V _{OUTLIM}	65		220	mV
Output Capacitance (Guaranteed by design)	C _{OUT}			350	pF
OUTPUTS REVERSE DIODE					
Reverse Output Current	I _{RD}	2,5			А
Reverse Peak current ⁽¹⁾	I _{RDP}	5.0			А
Reverse Voltage Drop					
- I _{OUT} = - 5A	V _{RD1}	1.0		1.7	V
- I _{OUT} = - 2,5A	V _{RD2}	0.85		1.7	V
POWERSTAGE PROTECTION					
Short Current Limit	I _{SCB}	3.0		5	А
V _{CC} Undervoltage	V _{CCMIN}	3.35		3.95	V
DIAGNOSTIC					
Short to GND Threshold Voltage for $I_{OUT} \leq 2A$	V _{REF}	$0.390 \mathrm{xV}_{\mathrm{CC}}$		$0.435 \mathrm{xV}_{\mathrm{CC}}$	V
Open Load Threshold Current	I _{OL}	10		50	mA
Pull-up Resistor	R _{OL}	2.0		8.0	kΩ
Temperature Detection Threshold	T _{OFF}	155		185	°C

Notes

1. For t \leq 2ms. Max. reverse current is limited to - 10A (for all outputs together)

ARCHIVE INFORMATION



DYNAMIC CHARACTERISTIC

Table 4. Dynamic Electrical Characteristics

Characteristics noted under conditions 7.0 V \leq V_{SUP} \leq 18 V, -40°C \leq T_A \leq 125°C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
NPUTS			1		
Input Frequency (NON1 to NON4)	f _{IN}	0.0		1000	Hz
OUTPUTS TIMING					
Positive Output Voltage Ramp (with inductive load)					
V _{OUT} = 4V 16V	OVR _{P1}	2.0	3.0	5.0	V/µs
V _{OUT} = 16V Vclp	OVR _{P2}	3.5	6.0	10	V/µs
Negative Output Voltage Ramp (25% 75%)	OVR _N	1.75	3.0	4.0	V/µs
Internal Switch-on-Time Charge Pump	t _{DCP}			40	μs
(NON = LOW $V_{GATE} = 0.9 * V_{BAT}$)					
Turn ON Delay	t _{DON}	1.0	2.5	5.0	μs
(NON = 50%, V _{OUT} = 0.9 * V _{BAT})					
Turn OFF Delay					
$(NON = 50\%, V_{OUT} = 0.1 * V_{BAT})$	t _{DOFFA}		1.0	3.0	μs
(NON = 50%, V _{OUT} = 4V)	t _{DOFFB}		4.7	7.5	μs
Undervoltage Protection	t _{RPON}			100	μs
Max ON time after a output voltage ramp from 0V to 25V at $V_{CC} = 0VV_{CCPRO}$					
Matching Turn ON Delay	t _{MON}	- 3.0		3.0	μs
(NON = 50%, V _{OUT} = 0.9 * V _{BAT})					
Rise time Turn OFF	t _{ROFF}		8.5	12	μs
(10% - 90% of V _{CLP})					
DIAGNOSTIC					
Short to GND Filter Time	T _{SCG}	140		250	μs
Open Load Filter Time	t _{OL}	140		250	μs
SERIAL DIAGNOSTIC LINK : LOAD CAPACITOR AT SDI AND SDO = 1	00PF		1		
Clock Frequency (50% duty cycle)	f _{CLK}	3.0			MHz
Minimum Time CLK = HIGH	t _{CLH}	100			ns
Minimum Time CLK = LOW	t _{CLL}	100			ns
Propagation Delay (CLF Data at SDO valid)	t _{PCLD}			100	ns
NCS = LOW to Data at SDO Valid	t _{PCLD}			100	ns
CLK Low Before NCS Low	t _{SCLCH}	100			ns
(Setup time CLK to NCS change High/Low)	5525				
CLK Change Low/High after NCS = Low	t _{HCLCL}	100			ns
SDI Input Set up Time	t _{SCLD}	20			ns
(CLK change High/Low after SDI data valid)					
SDI Input Hold Time (SDI data hold after CLK change High/Low)	t _{HCLD}			20	ns
CLK Low Before NCS High	t _{SCLCL}	150			ns

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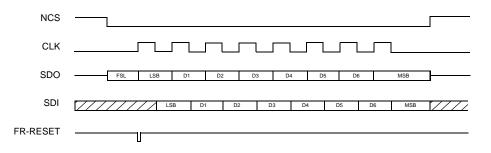
Table 4. Dynamic Electrical Characteristics (continued)

Characteristics noted under conditions 7.0 V \leq V_{SUP} \leq 18 V, -40°C \leq T_A \leq 125°C, GND = 0 V unless otherwise noted. Typical values noted reflect the approximate parameter means at T_A = 25°C under nominal conditions unless otherwise noted.

Characteristic	Symbol	Min	Тур	Max	Unit
CLK High After NCS High	t _{HCLCH}	150			ns
NCSLow/High to Output Data Flout	t _{PCHDZ}			100	ns
Capacitance at SDI, SDO, CLk, CS	t _{PCLD}			10	pF
NCS Filter time (Pulses $\leq t_{FNCS}$ will be ignored)	t _{FNCS}	10		40	ns

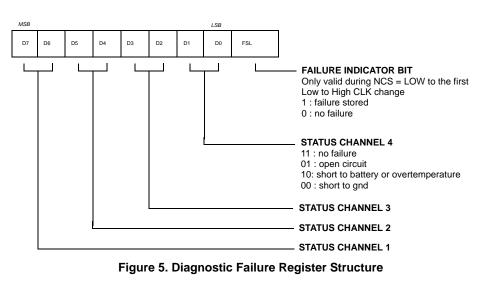


TIMING DIAGRAMS



NOTE : FR -RESET means Reset failure storage (internal signal)





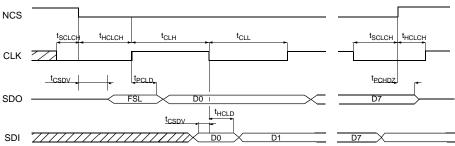
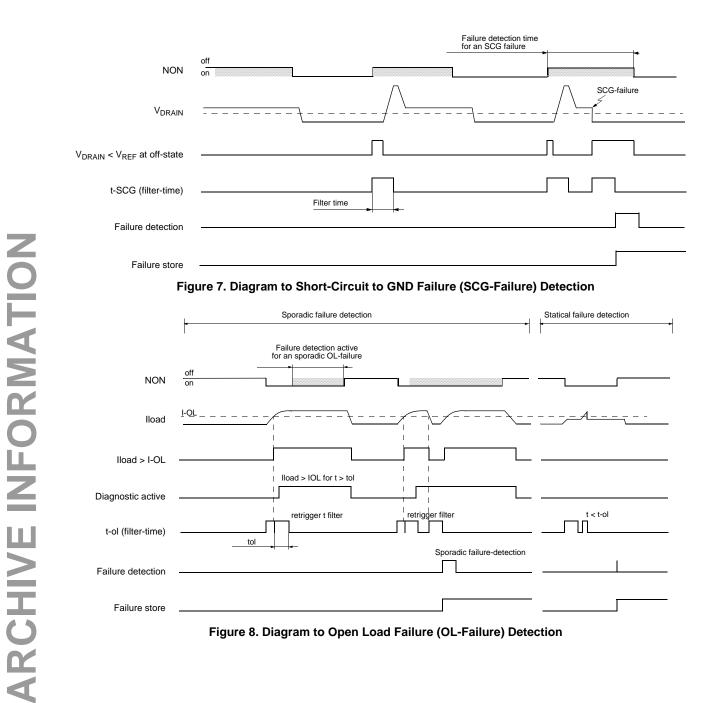


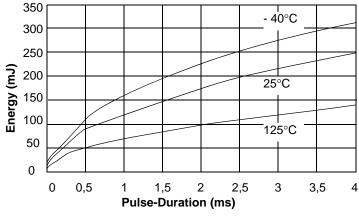
Figure 6. Serial Interface Timing

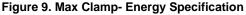














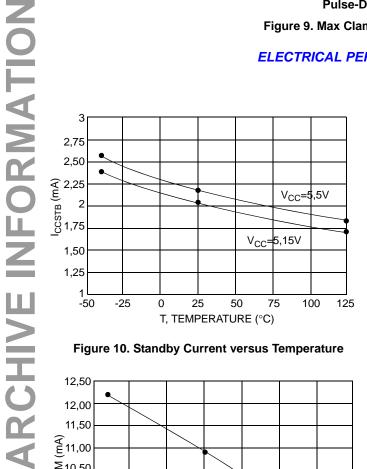


Figure 10. Standby Current versus Temperature

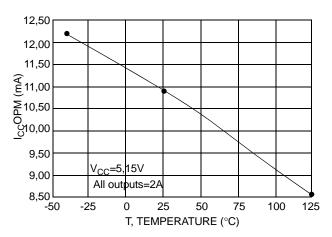


Figure 11. Operating Mode Current versus Temperature

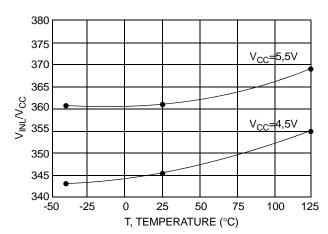
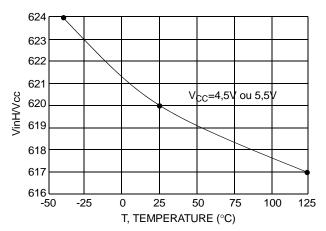
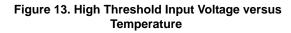
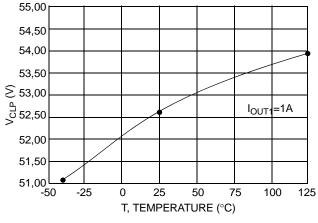


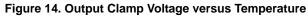
Figure 12. Low Threshold Input Voltage versus Temperature

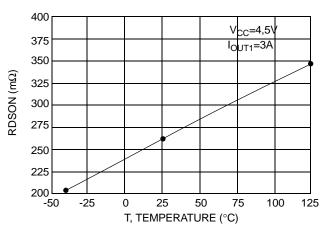


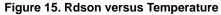












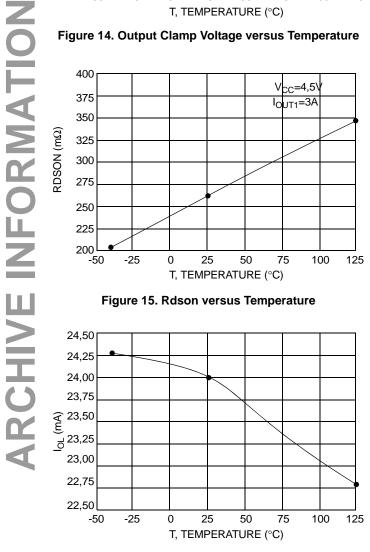


Figure 16. Open Load versus Temperature

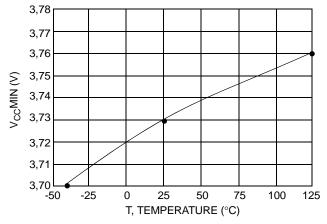
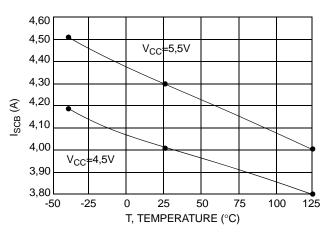


Figure 17. Vcc Undervoltage versus Temperature





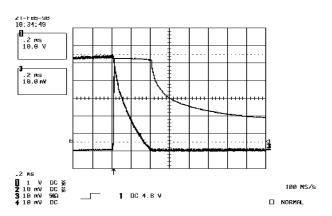
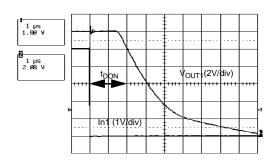
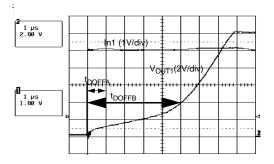


Figure 19. Inductive Switching



ARCHIVE INFORMATION





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Figure 20. Turn on Delay

Figure 21. Turn off Delay



FUNCTIONAL DESCRIPTION

INTRODUCTION

The device is a Quad Low-side Driver driven by four CMOS input stages. Each output power transistor is protected against short to V_{BAT} by a zener clamp against overvoltage.

A diagnostic logic recognizes four failure types at the output stage : overcurrent, short to GND, open-load and overtemperature.

The failures are individually stored in a byte which can be read out via the serial interface (SPI).

OUTPUT STAGE CONTROL

Each of the four output stages is switched ON and OFF by an individual control line (NON-Input). The logic level of the control line is CMOS compatible. The output transistors are switched off when the inputs are not connected.

POWER TRANSISTORS

INFORMATIO

RCHIVE

Each of the four output stages has its own zener clamp. This causes a voltage limitation at the power transistors when inductive loads are switched off. The drain voltage ramp occurring when output is switched on or off, is within defined limits. Output transistors can be connected in parallel to increase current capability. In this case, the associated inputs should be connected together.

SHORT-CIRCUIT AND OVERTEMPERATURE PROTECTION

If the output current increases above the short current limit for a time longer than t_{SCB} or if the temperature increases above T_{OFF} then the power transistor is immediately switched off. It remains switched off until the control signal on the NON-Input is switched off and on again.

DIAGNOSTICS

The following failures at the output stage are recognized :
Short -Circuit to V_{BAT} or overtemp = SCB (Highest priority)
Short -Circuit to GND = SCG

Open Load..... = OL (Lowest priority)

The SCB failure is recognized by an overcurrent (current above the short current limit) or an overtemperature.

If the current through the output stage is lower than the IOL-reference, after a filter time an OL failure will be recognized. This measurement is active while the power stage is switched on.

The SCG failure will recognize when the drain voltage is lower than the OL reference limit, while the output stage is switched off. All four outputs have an independent overtemperature detection and shutdown. All failures are stored in individual registers.

They can be read by the microprocessor via the serial interface. There is no failure detected if the power stage control time is shorter than the filter time.

DIAGNOSTIC INTERFACE

The communication between the microprocessor and the failure register runs via the SPI link. If there is a failure stored in the failure register, the first bit of the shift register is set to a high level. With the High/Low change on the NCS pin, the first bit of the diagnostic shift register will be transmitted to the SDO output. The SDO output is the serial output from the diagnostic shift register and it is put into a tri-state when the NCS pin is high. The CLK pin clocks the diagnostic shift register. New SDO data will appear on every rising edge of this pin and new SDI data will be latched on every CLK's falling edge into the shift register. With the first positive pulse of the CLK, the failure register will be cleared. There is no bus collision at a small spike at the NCS. The CLK is always LOW while the NCS-signal is changing.

RESET

There are two different reset functions realized :

Under voltage reset : as long as the V_{CC} voltage is lower than V_{CCRES} , the power stages are switched off and the failure-registers are reset.

Reset pin : as long as the NRES-pin is low, following circuits are reset :

- Power stages
- · Failure register

UNDERVOLTAGE PROTECTION

At low V_{CC} voltage, the device remains switched off even if there is a voltage ramp at the OUT pin.



ARCHIVE INFORMATION

PACKAGING

PACKAGE DIMENSIONS

For the most current package revision, visit www.freescale.com and perform a keyword search using the "98A" listed below.

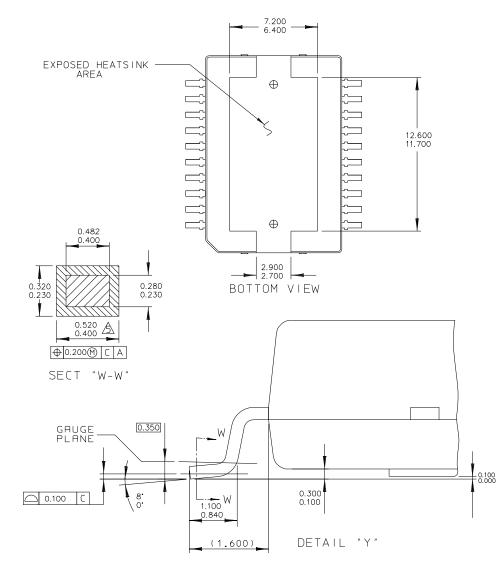
PIN ONE ID 1.100X 45° 2.700 2.500 1.100 0.900 \bigcirc 20 18X 1.270 16.000 15.800 1.270 11 10 11.100 10.900 В А 10X 14.450 13.950 ⊕0.100 M C B H DATUM PLANE 3.400 3.000 3.100 2.900 SEATING PLANE С

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TITLE:		DOCUMENT NO]: 98ASH70702A	RE∨: B
20 LEAD HSOP W/PROTRUDING HEATSINK		CASE NUMBER	8: 979	11 OCT 2005
		STANDARD: NE	IN-JEDEC	

DH SUFFIX VW (PB-FREE) SUFFIX 20-PIN HSOP PLASTIC PACKAGE 98ASH70702A ISSUE B



PACKAGE DIMENSIONS (CONTINUED)



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TITLE: 20 LEAD HSOP W/PROTRUDING HEATSINK		DOCUMENT NO	RE∨: B	
		CASE NUMBER	2: 979	11 OCT 2005
		STANDARD: NE	IN-JEDEC	

DH SUFFIX VW (PB-FREE) SUFFIX 20-PIN HSOP PLASTIC PACKAGE 98ASH70702A ISSUE B

ARCHIVE INFORMATION



REVISION HISTORY

REVISION	DATE	DESCRIPTION OF CHANGES
6.0	11/2006	 Implemented Revision History page Added Pb-Free suffix code VW Converted to Freescale format, and adjusted to the prevailing form and style



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